/ Descriptions

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/ Features

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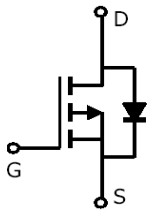
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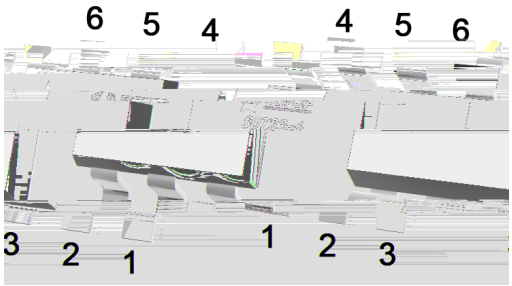
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/ Applications

/ Equivalent Circuit

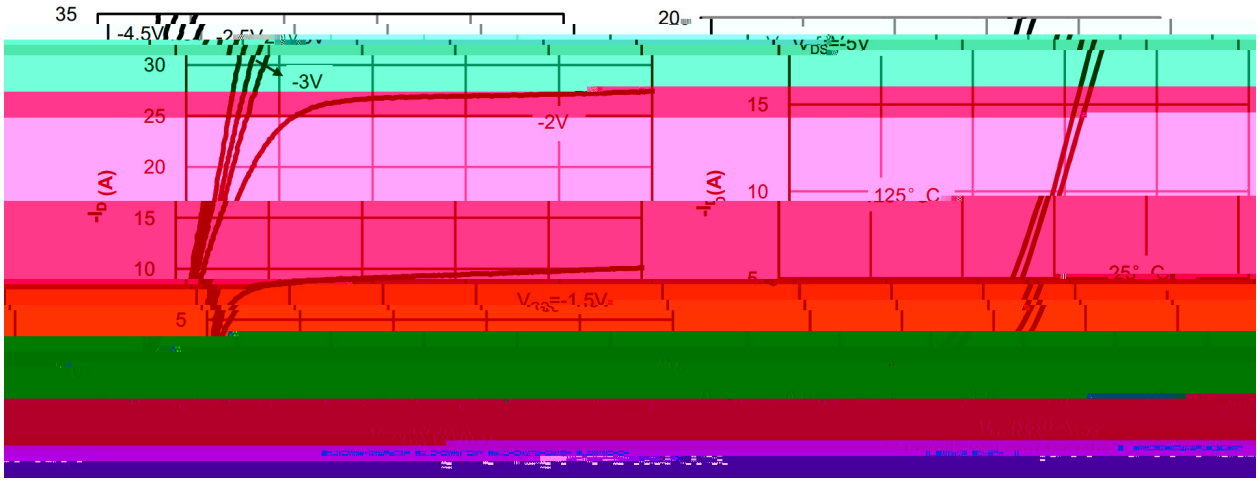


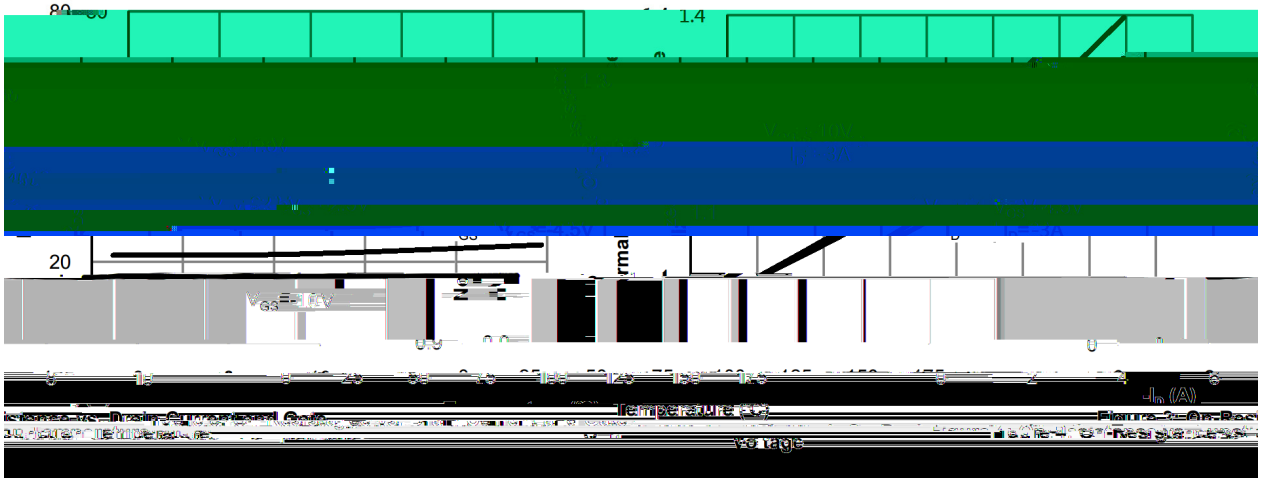
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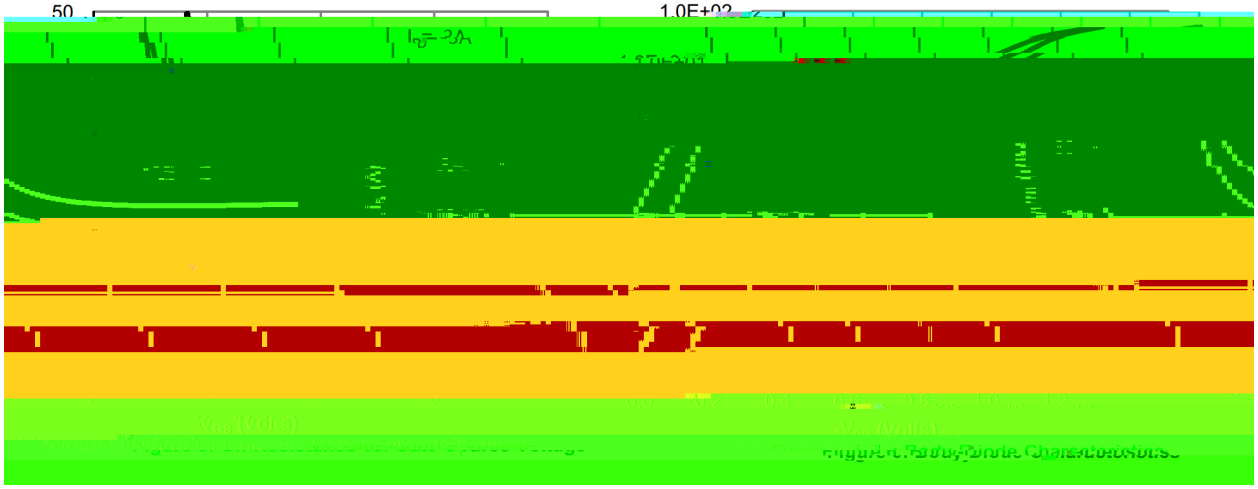


/ Marking

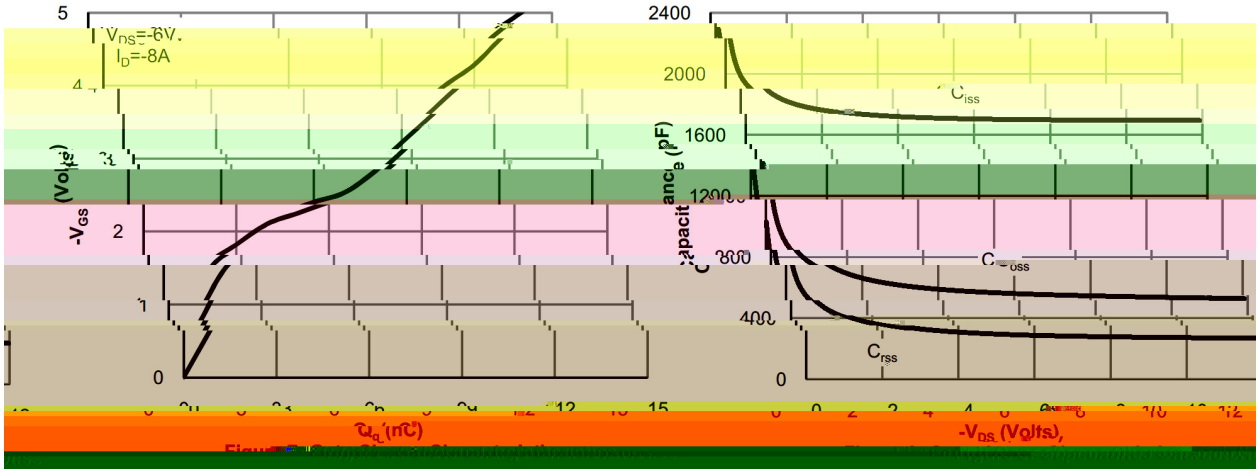
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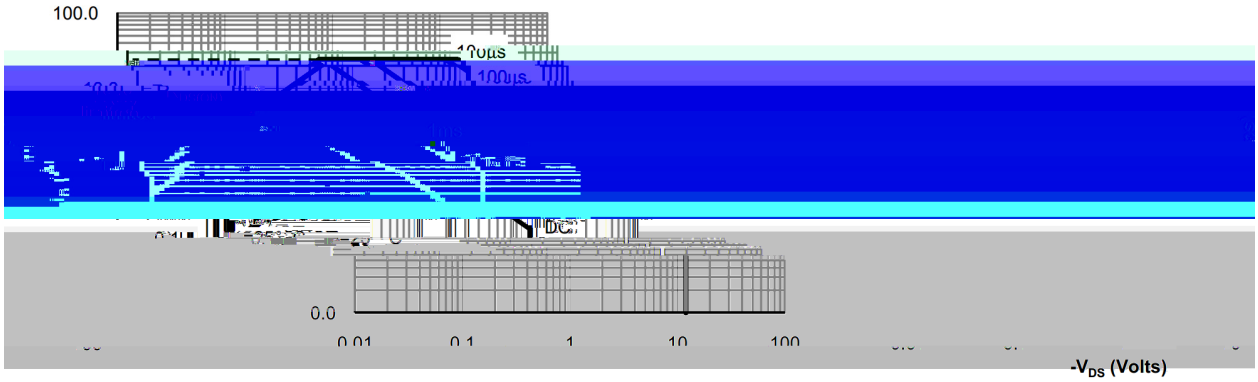






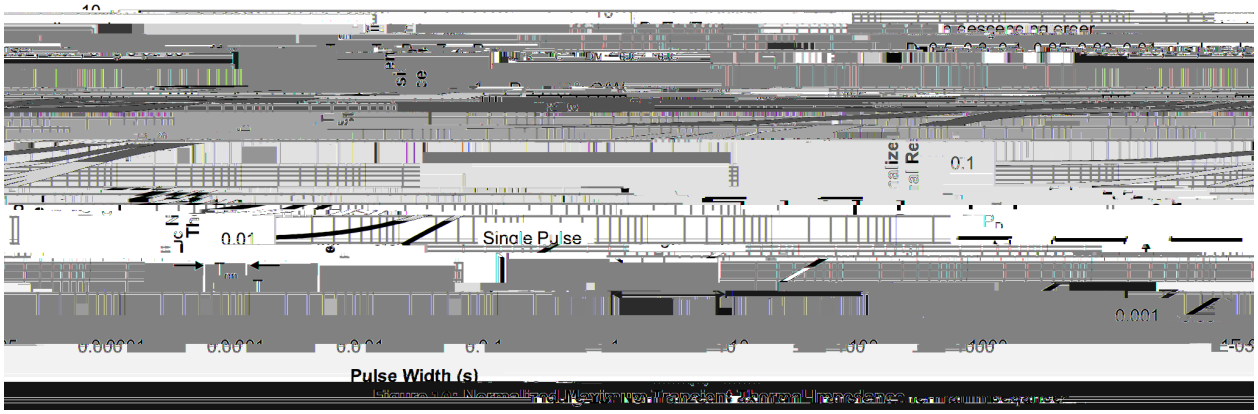
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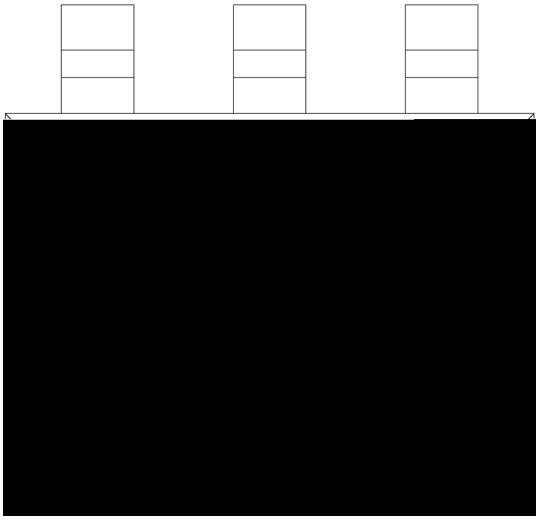


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Figure 9: Maximum Forward Biased Sa Operating Area



/ Marking Instructions



( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box